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FDMA1023PZ Dual P-Channel PowerTrench[®] MOSFET –20V, –3.7A, 72mΩ

Features

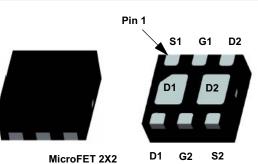
- Max r_{DS(on)} = 72mΩ at V_{GS} = -4.5V, I_D = -3.7A
- Max $r_{DS(on)}$ = 95m Ω at V_{GS} = -2.5V, I_D = -3.2A
- Max $r_{DS(on)}$ = 130m Ω at V_{GS} = -1.8V, I_D = -2.0A
- Max r_{DS(on)} = 195mΩ at V_{GS} = -1.5V, I_D = -1.0A
- Low profile 0.8 mm maximum in the new package MicroFET 2x2 mm
- HBM ESD protection level > 2kV typical (Note 3)
- RoHS Compliant
- Free from halogenated compounds and antimony oxides

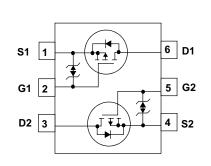


General Description

This device is designed specifically as a single package solution for the battery charge switch in cellular handset and other ultra-portable applications. It features two independent P-Channel MOSFETs with low on-state resistance for minimum conduction losses. When connected in the typical common source configuration, bi-directional current flow is possible.

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V _{DS}	Drain to Source Voltage	-20	V	
V _{GS}	Gate to Source Voltage		±8	V
ID	Drain Current -Continuous (Note 1a)		-3.7	
	-Pulsed		-6	— A
P _D	Power Dissipation	(Note 1a)	1.5	W
		(Note 1b)	0.7	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance for Single Operation, Junction to Ambient	(Note 1a)	86	
R_{\thetaJA}	Thermal Resistance for Single Operation, Junction to Ambient	(Note 1b)	173	°C/W
R_{\thetaJA}	Thermal Resistance for Dual Operation, Junction to Ambient	(Note 1c)	69	C/VV
$R_{\theta JA}$	Thermal Resistance for Dual Operation, Junction to Ambient	(Note 1d)	151	

Package Marking and Ordering Information

Device	Marking	Device	Package	Reel Size	Tape Width	Quantity
C)23	FDMA1023PZ	MicroFET 2X2	7"	8mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250μA, V _{GS} = 0V	-20			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		-11		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16V, V_{GS} = 0V$			-1	μA
GSS	Gate to Source Leakage Current	$V_{GS} = \pm 8V, V_{DS} = 0V$			±10	μA
)n Chara	cteristics					
/ _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-0.4	-0.7	-1.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		2.5		mV/°C
r _{DS(on)}		$V_{GS} = -4.5V, I_D = -3.7A$		60	72	 mΩ
		$V_{GS} = -2.5V, I_D = -3.2A$		75	95	
	Static Drain to Source On-Resistance	$V_{GS} = -1.8V, I_D = -2.0A$		100	130	
· · /		$V_{GS} = -1.5V, I_D = -1.0A$		130	195	
		$V_{GS} = -4.5V, I_D = -3.7A, T_J = 125^{\circ}C$		81	91	
9 _{FS}	Forward Transconductance	$V_{DS} = -5V, I_{D} = -3.7A$		12		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			490	655	pF
C _{oss}	Output Capacitance	$-V_{DS} = -10V, V_{GS} = 0V,$		100	135	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		90	135	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time			9	18	ns
t _r	Rise Time	$V_{DD} = -10V, I_D = -1A$ $-V_{GS} = -4.5V, R_{GEN} = 6\Omega$		12	22	ns
t _{d(off)}	Turn-Off Delay Time			64	103	ns
f	Fall Time	-		37	60	ns
Q _{g(TOT)}	Total Gate Charge	$V_{DD} = -10V, I_D = -3.7A$ $V_{GS} = -4.5V$		8.6	12	nC
Q _{gs}	Gate to Source Gate Charge			0.7		nC
Q _{gd}	Gate to Drain "Miller" Charge			2.0		nC
Drain-Sou	Irce Diode Characteristics					
I _S	Maximum Continuous Source-Drain Diode	e Forward Current			-1.1	A
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_{S} = -1.1A$ (Note 2)		-0.8	-1.2	V
-	Reverse Recovery Time			32	48	ns
t _{rr}	Reverse Recovery Charge	− I _F = −3.7A, di/dt = 100A/μs		15	23	nC

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Notes:

1: R_{0JA} is determined with the device mounted on a 1 in² oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design

user's board design. (a) $R_{\theta,JA} = 86^{\circ}C/W$ when mounted on a 1in² pad of 2 oz copper, 1.5" x 1.5" x 0.062" thick PCB. For single operation.

(b) R_{0JA} = 173°C/W when mounted on a minimum pad of 2 oz copper. For single operation.

(c) $R_{\theta JA}$ = 69°C/W when mounted on a 1in² pad of 2 oz copper, 1.5" x 1.5" x 0.062" thick PCB, For dual operation.

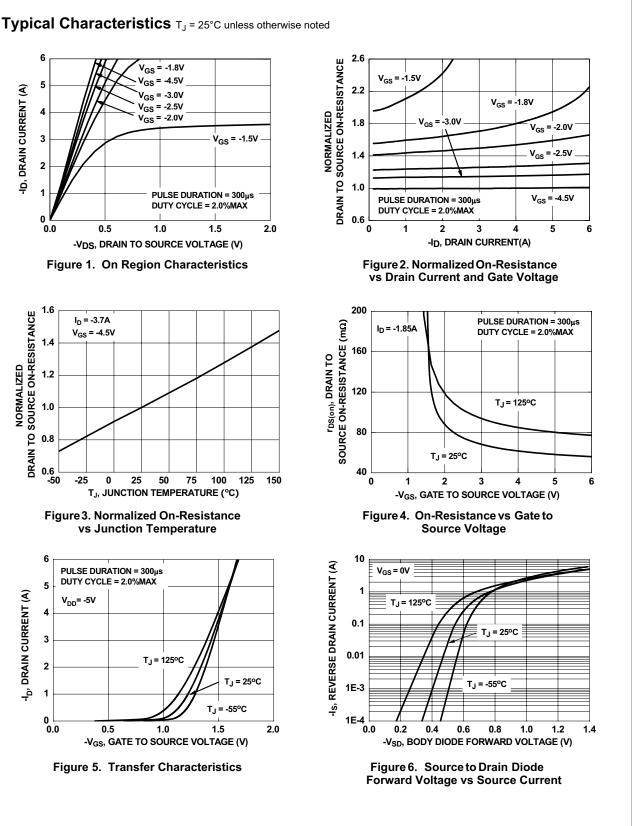
(d) $R_{\theta JA}$ = 151 $^{o}\text{C/W}$ when mounted on a minimum pad of 2 oz copper. For dual operation.



2: Pulse Test : Pulse Width < 300us, Duty Cycle < 2.0%

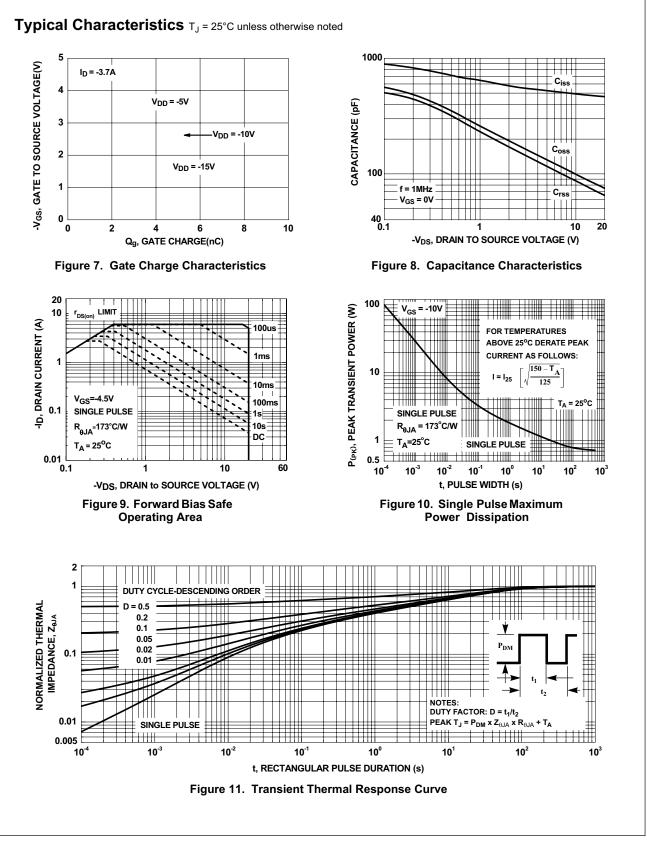
3: The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

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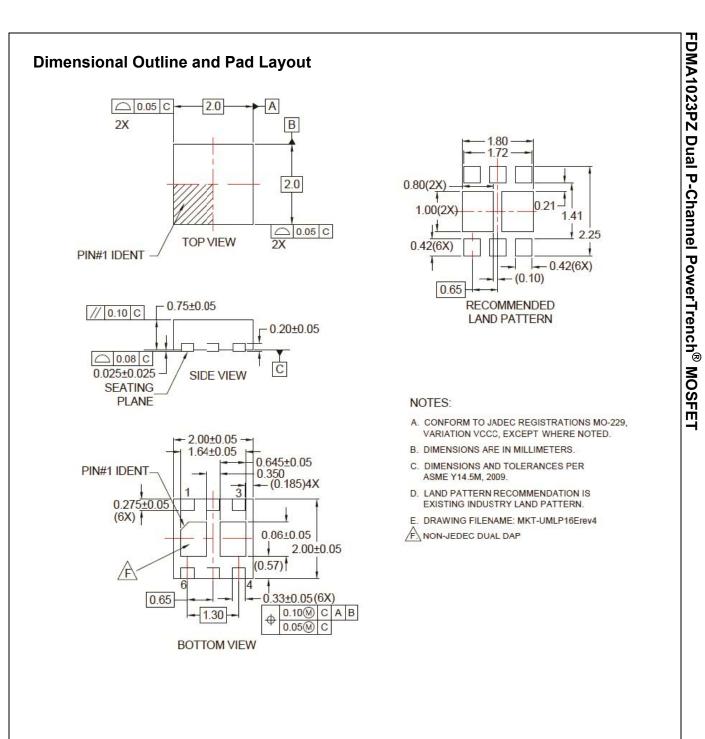
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